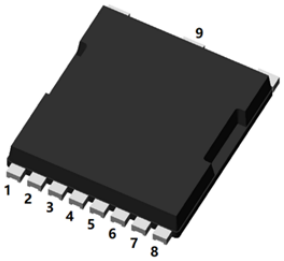
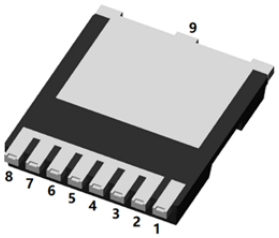
N-Channel Enhancement Mode Field Effect Transistor

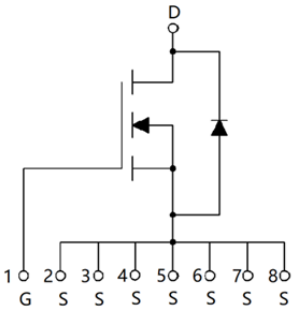


Top View



Bottom View

TOLL



Product Summary

- V_{DS} 100 V
- I_D 300 A
- $R_{DS(ON)}$(at V_{GS}=10V) ＜1.45mΩ
- $R_{DS(ON)}$(at V_{GS}=6V) ＜1.9mΩ
- 100% EAS Tested
- 100% ▽V_{DS} Tested

General Description

- Surface-mounted package
- Excellent package for heat dissipation
- High Density Cell Design for Low $R_{DS(on)}$
- Moisture Sensitivity Level 1
- Epoxy Meets UL 94 V-0 Flammability Rating

Applications

- High power inverter system
- Uninterruptible power supply
- LCDM appliances

■ Absolute Maximum Ratings (T_A=25℃ unless otherwise noted)

Parameter		Symbol	Limit	Unit
Drain-source Voltage		V_{DS}	100	V
Gate-source Voltage		V_{GS}	±20	V
Drain Current	T_A=25℃	I_D	30	A
	T_A=100℃		19	
	T_C=25℃		300	
	T_C =100℃		190	
Pulsed Drain Current [A]		I_{DM}	1200	A
Avalanche energy [B]		EAS	480	mJ
Total Power Dissipation [C]	T_A=25℃	P_D	4.15	W
	T_A=100℃		1.65	
	T_C=25℃		500	
	T_C =100℃		200	
Junction and Storage Temperature Range		T_J ,T_{STG}	-55～+150	℃

■Thermal resistance

Parameter		Symbol	Typ	Max	Units
Thermal Resistance Junction-to-Ambient [D]	Steady-State	$R_{\theta JA}$	20	30	℃/W
Thermal Resistance Junction-to-Case	Steady-State	$R_{\theta JC}$	0.2	0.25	

■ Ordering Information (Example)

PREFERED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
T300G10HJ	F1	T300G10HJ	2000	4000	20000	13“ reel

■ Electrical Characteristics (T_J=25℃ unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS}= 0V, I_D=250μA	100	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=100V, V_{GS}=0V	-	-	1	μA
		V_{DS}=100V, V_{GS}=0V, Tj=150℃	-	-	100	
Gate-Body Leakage Current	I_{GSS}	V_{GS}= ±20V, V_{DS}=0V	-	-	±100	nA
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}= V_{GS}, I_D=250μA	2	2.9	4	V
Static Drain-Source On-Resistance	$R_{DS(ON)}$	V_{GS}=10V, I_D=30A	-	1.2	1.45	mΩ
		V_{GS}=6V, I_D=15A	-	1.48	1.9	
Diode Forward Voltage	V_{SD}	I_S=30A, V_{GS}=0V	-	0.9	1.3	V
Maximum Body-Diode Continuous Current	I_S		-	-	300	A
Dynamic Parameters						
Input Capacitance	C_{iss}	V_{DS}=50V, V_{GS}=0V, f=1MHz	-	13000	-	pF
Output Capacitance	C_{oss}		-	2100	-	
Reverse Transfer Capacitance	C_{rss}		-	120	-	
Switching Parameters						
Total Gate Charge	Q_g	V_{GS}=10V, V_{DS}=50V, I_D=30A	-	240	-	nC
Gate-Source Charge	Q_{gs}		-	60	-	
Gate-Drain Charge	Q_{gd}		-	60	-	
Reverse Recovery Charge	Q_{rr}	I_F=30A, di/dt=100A/us	-	380	-	nC
Reverse Recovery Time	t_{rr}		-	130	-	ns
Turn-on Delay Time	$t_{D(on)}$	V_{GS}=10V, V_{DD}=50V, I_D=30A R_{GEN}=2.2Ω	-	30	-	ns
Turn-on Rise Time	t_r		-	60	-	
Turn-off Delay Time	$t_{D(off)}$		-	160	-	
Turn-off fall Time	t_f		-	70	-	

A. Repetitive rating; pulse width limited by max. junction temperature.
B. T_J=25℃, V_{DD}=50V, V_G=10V, R_G=25Ω, L=1mH, IAS=31A.
C. P_d is based on max. junction temperature, using junction-case thermal resistance.
D. The value of $R_{\theta JA}$ is measured with the device mounted on the minimum recommend pad size, in the still air environment with T_A =25℃. The maximum allowed junction temperature of 150℃. The value in any given application depends on the user's specific board design.

■Typical Electrical and Thermal Characteristics Diagrams

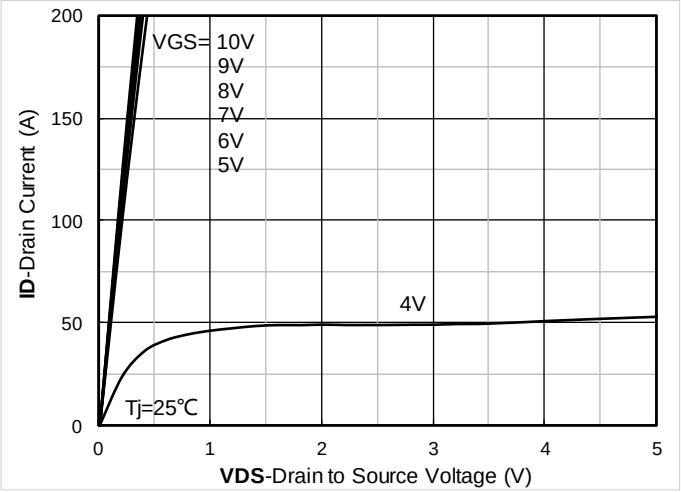


Figure 1. Output Characteristics

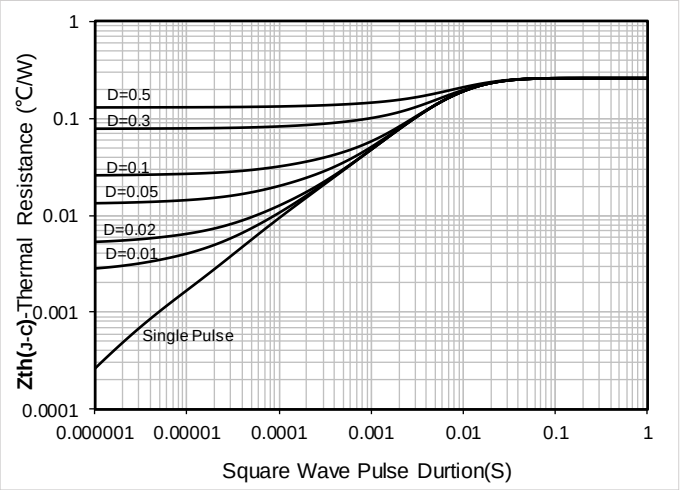


Figure 2. Maximum Transient Thermal Impedance

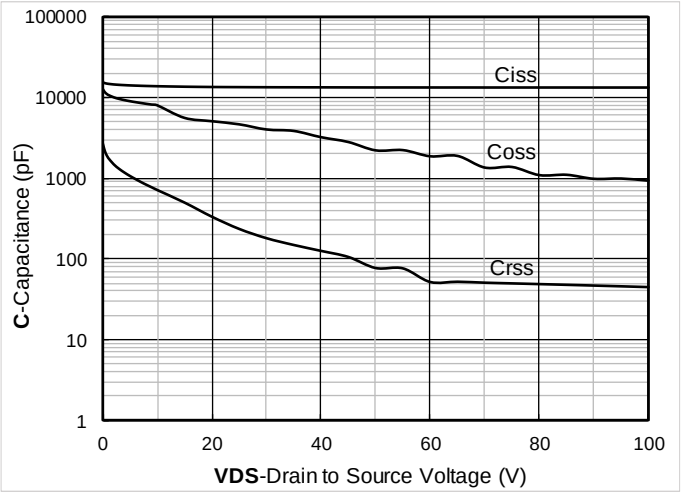


Figure 3. Capacitance Characteristics

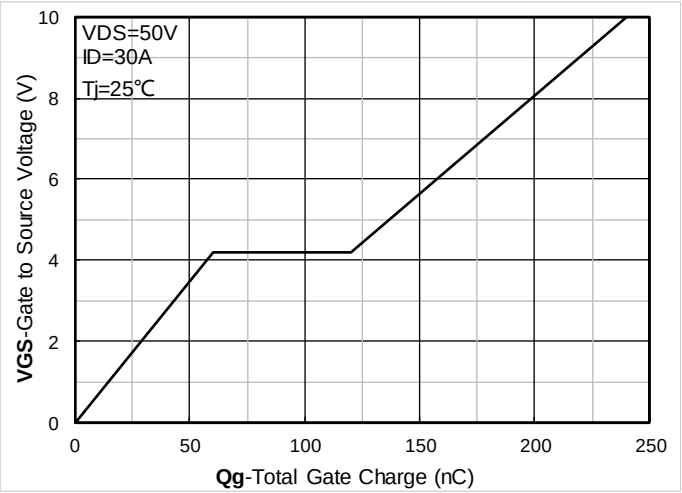


Figure 4. Gate Charge

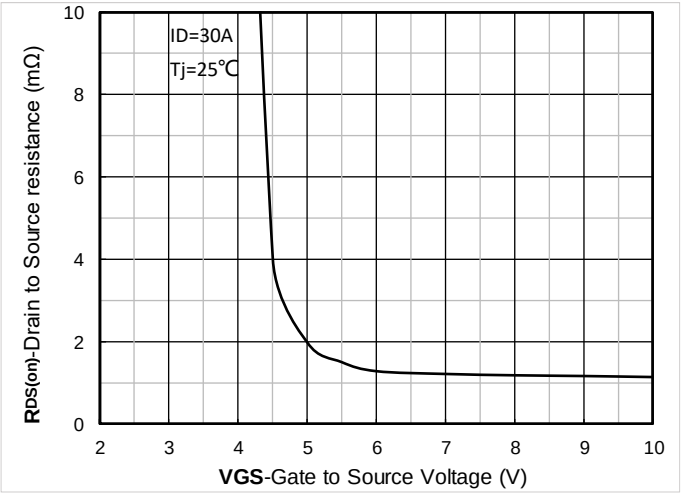


Figure 5. On-Resistance vs Gate to Source Voltage

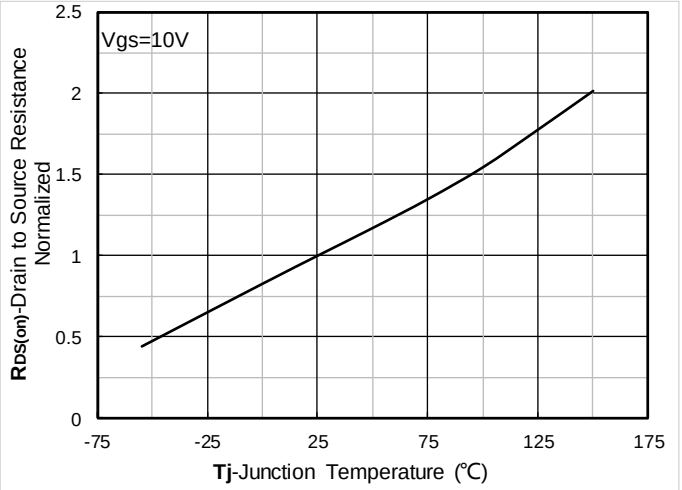


Figure 6. Normalized On-Resistance

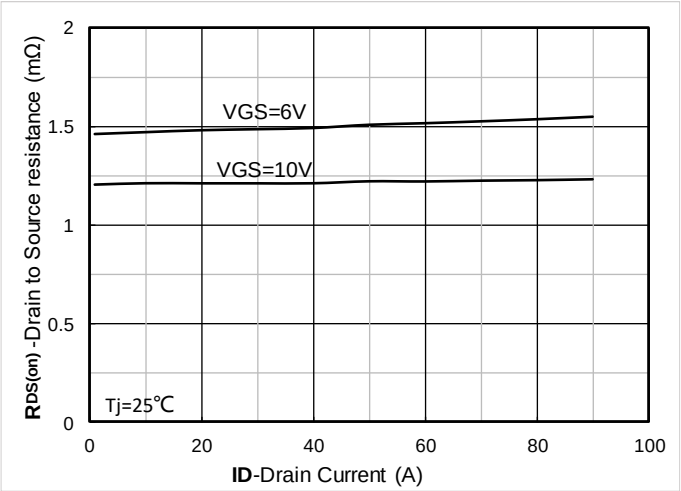


Figure 7. $R_{DS(on)}$ VS Drain Current

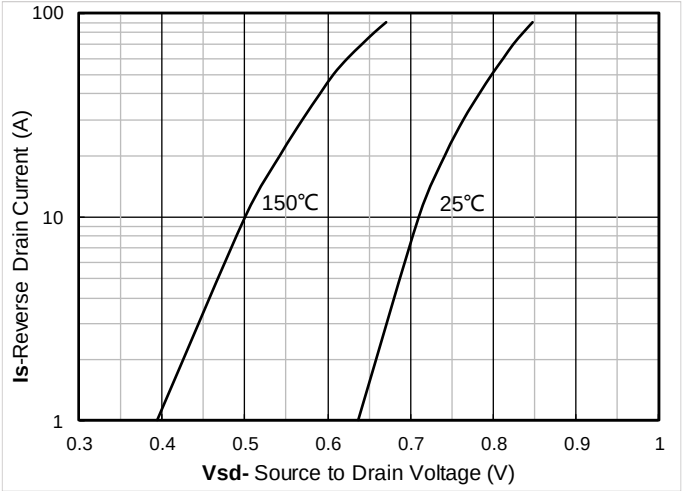


Figure 8. Forward characteristics of reverse diode

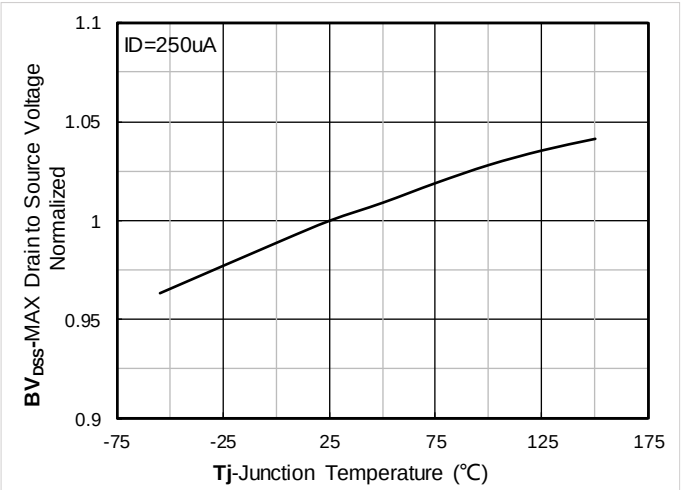


Figure 9. Normalized breakdown voltage

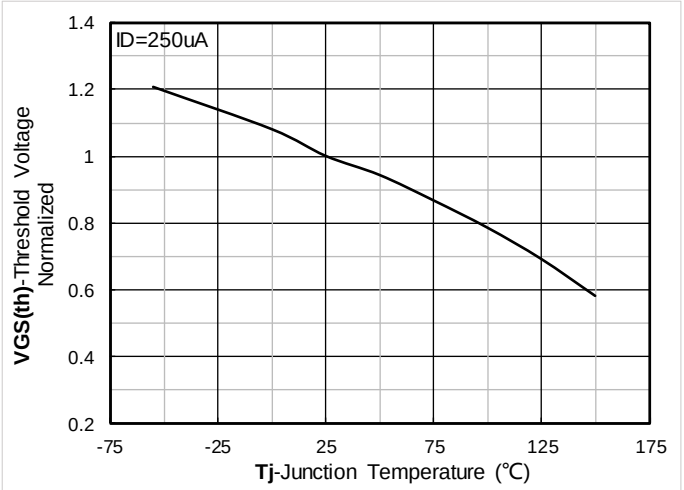


Figure 10. Normalized Threshold voltage

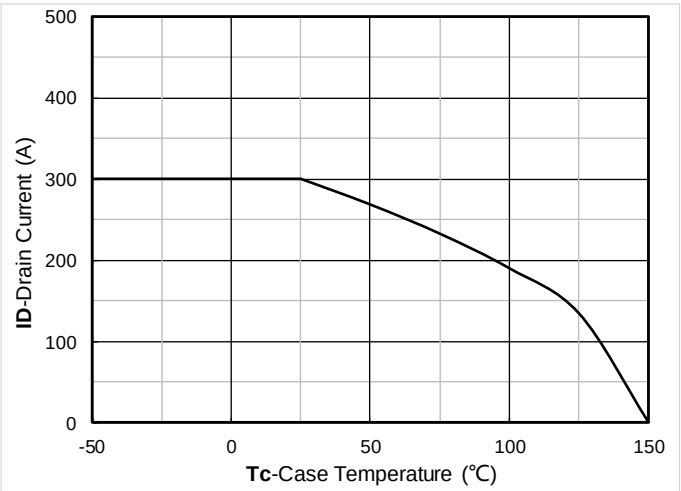


Figure 11. Current dissipation

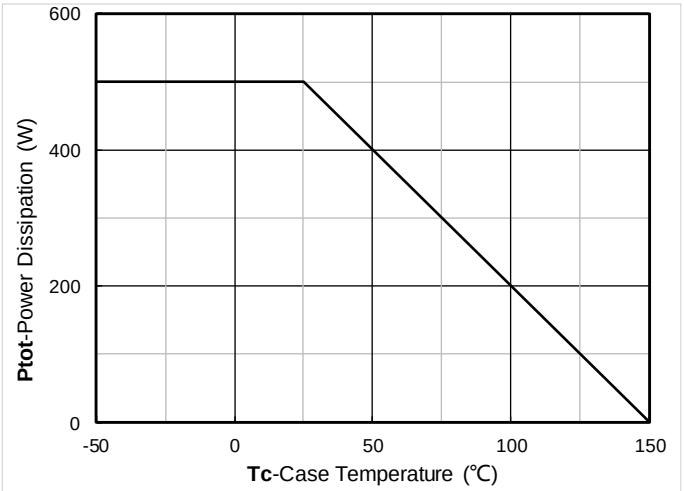


Figure 12. Power dissipation

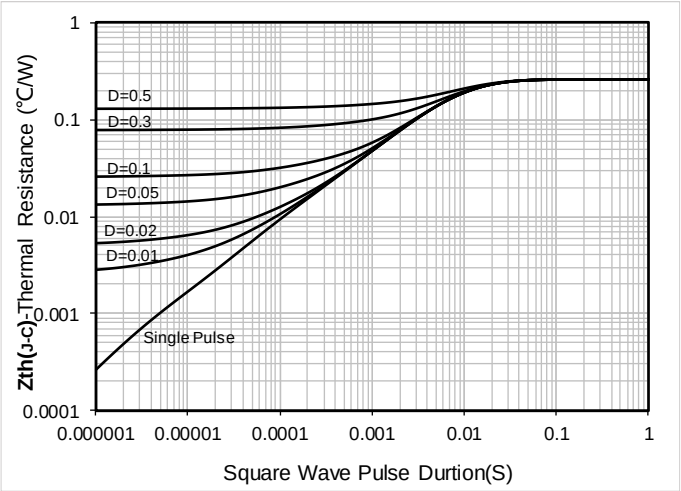


Figure 13. Maximum Transient Thermal Impedance

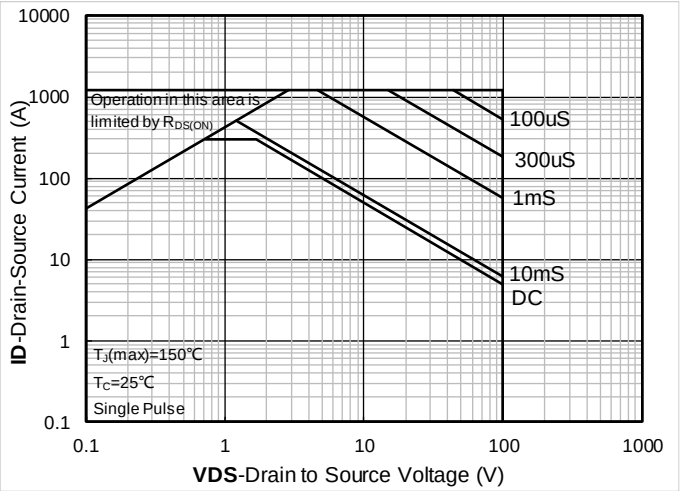
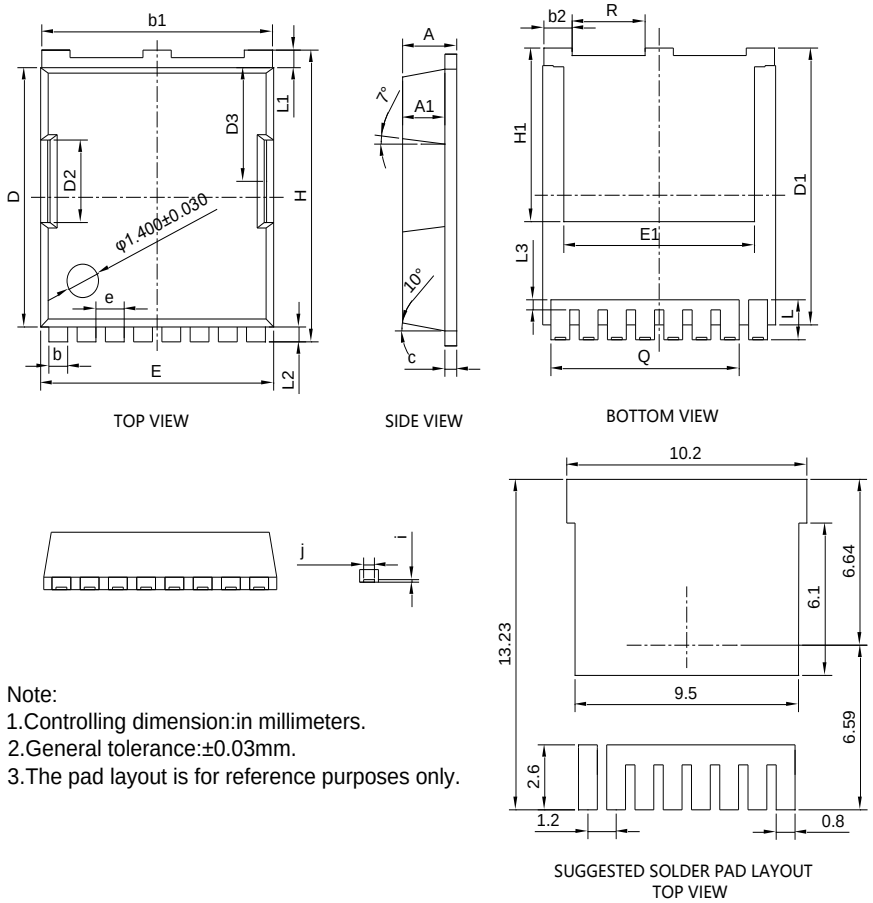


Figure 14. Safe Operation Area

■ TOLL Package information



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	2.2	2.3	2.4
A1	1.7	1.8	1.9
b	0.7	0.8	0.9
b1	9.7	9.8	9.9
b2	1.1	1.2	1.3
c	0.4	0.5	0.6
D	10.28	10.38	10.48
D1	10.98	11.08	11.18
D2	3.2	3.3	3.4
D3	4.45	4.55	4.65
E	9.8	9.9	10
E1	8	8.1	8.2
e	1.2 BSC		
H	11.58	11.68	11.78
H1	6.95 BSC		
i	0.1 REF		
j	0.46 REF		
L	1.5	1.6	1.7
L1	0.6	0.7	0.8
L2	0.5	0.6	0.7
L3	0.3	0.4	0.5
Q	8 REF		
R	3.0	3.1	3.2

Note:
1.Controlling dimension:in millimeters.
2.General tolerance:±0.03mm.
3.The pad layout is for reference purposes only.

UNIT：mm

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